

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









# **DUAL FULL BRIDGE**

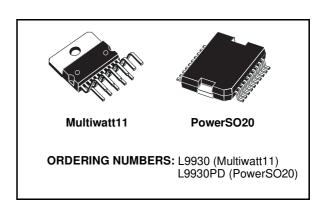
- $R_{DS ON} = 2\Omega$
- INTERNAL CLAMPING VOLTAGE = 32V
- INTERNAL FREE WHEELING DIODES
- PARALLEL DRIVE CAPABILITY
- RESISTIVE OR INDUCTIVE LOAD

#### PROTECTION:

- TEMPERATURE PROTECTION
- SHORT-CIRCUIT PROTECTION (Vbat, LOAD, GND)

#### **DETECTION:**

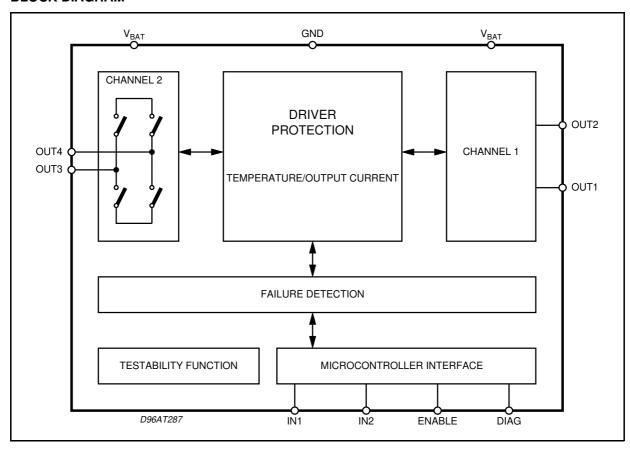
- SHORTED LOAD
- OPEN LOAD
- OVERTEMPERATURE



#### **DESCRIPTION**

The L9930 is a dual full-bridge. The output stages are Power Mos switches.

#### **BLOCK DIAGRAM**

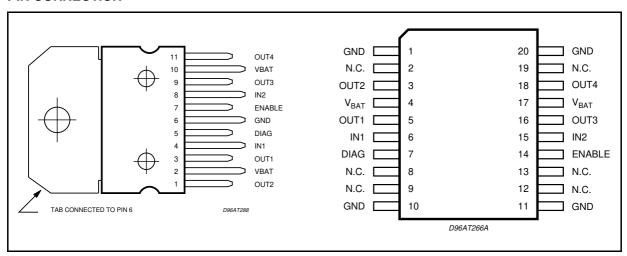


September 2013 1/12

# **ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
Е	Clamped Energy at the Switching off	6 (max)	mJ
V <sub>out DC</sub>	Continuous Output Voltage	24 (max)	V
V <sub>out tr</sub>	Transient Output Voltage	32 (max)	V
V <sub>bat DC</sub>	Continuous Battery Voltage	8 to 24	V
V <sub>bat tr</sub>	Transient Battery Voltage	45 (max)	V
l <sub>out</sub>	Reverse Output Current	– 2 (max)	Α
f <sub>in</sub>	Input Frequency	500 (max)	Hz
V <sub>in</sub>	Input Voltage	- 0.3 to +7	V
$V_{diag}$	Diagnostic Voltage	- 0.3 to +7	V
Ts	Storage Temperature	- 55 to 150	°C
T <sub>j</sub>	Operating Junction Temperature	- 40 to 150	°C
V <sub>ESD</sub>	V <sub>ESD</sub> (Note MIL STD 883C)	3000	V

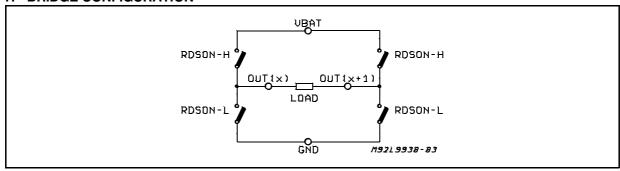
# **PIN CONNECTION**



#### **PIN FUNCTIONS**

MW11	PowerSO20	Name	Function
1	3	OUT 2	Output Channel 1
2	4	$V_{BAT}$	Power Supply
3	5	OUT 1	Output Channel 1
4	6	IN 1	Input Channel 1
5	7	DIAG	Diagnostic Output Common for the 2 Channels
6	1, 10, 11, 20	GND	Ground
7	14	ENABLE	Enable
8	15	IN 2	Input Channel 2
9	16	OUT 3	Output Channel 2
10	17	$V_{BAT}$	Power Supply
11	18	OUT 4	Output Channel 2
	2, 8, 9, 12, 13, 19	NC	Not Connected

# **H - BRIDGE CONFIGURATION**



#### **THERMAL DATA**

Symbol	Parameter	Value	Unit
R <sub>th j-case</sub>	Thermal Resistance Junction to Case max.		°C/W
R <sub>th j-amb</sub>	Thermal resistance Junction to Ambient max.		°C/W

# **ELECTRICAL CHARACTERISTICS** ( $V_{bat} = 8 \text{ to } 18V \text{ tJ} = -40 \text{ to } +150^{\circ}\text{C}$ , unless otherwise specified.)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
R <sub>DSon-H</sub>	ON Resistance	$I_{out} = 0.5A$		2	4.3	Ω
R <sub>DSon-L</sub>	ON Resistance	$I_{out} = 0.5A$		2	4.3	Ω
$V_{OCL}$	Clamping Voltage	$I_{out} = 0.1A$		32		V
$V_{F}$	Clamp Diode Forward Voltage	$I_{out} = 0.5A$		1.3		V
T <sub>R</sub>	Output Voltage Rise Time	V <sub>out</sub> ; 0.1 to 0.9 V <sub>out</sub> (see fig. 1) NOT LOADED		50	100	μs
T <sub>F</sub>	Output Voltage Fall Time	Vout; 0.9 to 0.1 V <sub>out</sub> (see fig. 1) NOT LOADED		50	100	μs
T <sub>DR</sub>	Input to Output Rising edge Delay	0.5 V <sub>IN</sub> to 0.1 V <sub>out</sub> (see fig. 1) NOT LOADED			50	μs
T <sub>DF</sub>	Input to Output Falling Edge Delay	0.5 VIN to 0.9 V <sub>out</sub> (see fig. 1) NOT LOADED			50	μs

# **OUTPUT PROTECTIONS CHARACTERISTICS**

I <sub>SC</sub>	Short Circuit	$T_{amb} = -40$ °C	0.45		2.6	Α
	Typical Application (see fig 2)	$T_{amb} = 25$ °C	0.38		2.6	Α
		T <sub>amb</sub> = 125°C	0.28		2.6	Α
I <sub>SC</sub>	Short Circuit Typical Application with Shottky Diodes (see fig 3)		0.8		2.6	Α
T <sub>SD</sub>	Temperature		160			°C
T <sub>HYST</sub>	Temperature Hysteresis			20		°C

These protections switch off the full bridge.

#### **OUTPUT DETECTIONS CHARACTERISTICS**

Į	R <sub>OPL-L</sub>	Open-load Threshold Resistor	80		Ω
	$R_{OPL-H}$		100		Ω

#### SUPPLY CHARACTERISTICS

I <sub>QHI</sub>	Supply Current	$\begin{aligned} R_{LOAD1} &= R_{LOAD2} = \infty \\ V_{BAT} &= 14V, \\ IN1 &= IN2 = ENABLE = 5V \end{aligned}$		15	mA
I <sub>QLO</sub>		$\begin{aligned} R_{load1} &= R_{load2} = 50\Omega\\ V_{BAT} &= 12V, ENABLE = 0V\\ IN1 &= IN2 = 0V \end{aligned}$		0.5	mA

# **ELECTRICAL CHARACTERISTICS**

INPUTS CHARACTERISTICS (normal and standby mode)

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Unit
$V_{IH}$	High Threshold				4	٧
$V_{IL}$	Low Threshold		1			٧
I <sub>NHI</sub>	Input Current 1	$V_{IN} = 4V$			200	μΑ
I <sub>NLO</sub>	Input Current 2	$V_{IN} = 1V$			50	μΑ

# DIAGNOSTIC CHARACTERISTICS

	$V_{DIAGL}$	Low Level Voltage	I <sub>DIAG</sub> = 2mA	0.6	0.8	V
Ī	I <sub>DIAGH</sub>	Leakage Current	V <sub>DIAG</sub> = 5.25V	5	10	μΑ

# INITIALIZATION CHARACTERISTICS

T <sub>INIT</sub>	Initialization Timing	V <sub>BAT</sub> = 12V	10		μs
T <sub>STUP</sub>	Start-Up Timing	V <sub>BAT</sub> = 12V	1		ms
T <sub>RESET</sub>	Reset		10		μs

# FILTER CHARACTERISTICS

T <sub>FILTER</sub>	64	112	170	μs
$T_{DIAG}$	4	6	10	μs
T <sub>SYNC</sub>	4	6	10	μs

# **TRUE TABLE**

ENAB	IN1	IN2	OUT1	OUT2	OUT3	OUT4	MODE	DIAG
0	0	0	HZ	HZ	HZ	HZ	STANDBY	?
0	0	1	HZ	HZ	HZ	HZ	NORMAL	?
0	1	0	HZ	HZ	HZ	HZ	NORMAL	?
0	1	1	HZ	HZ	HZ	HZ	NORMAL	?
1	0	0	HSD	LSD	HSD	LSD	NORMAL	VALID
1	0	1	HSD	LSD	LSD	HSD	NORMAL	VALID
1	1	0	LSD	HSD	HSD	LSD	NORMAL	VALID
1	1	1	LSD	HSD	LSD	HSD	NORMAL	VALID

Figure 1:

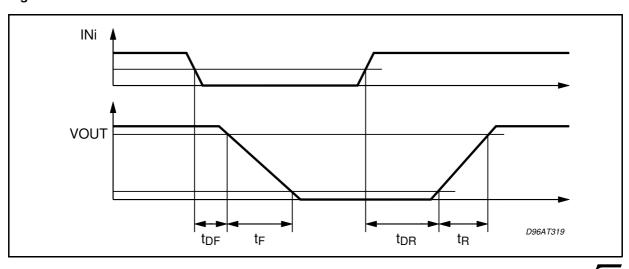


Figure 2: Typical Application

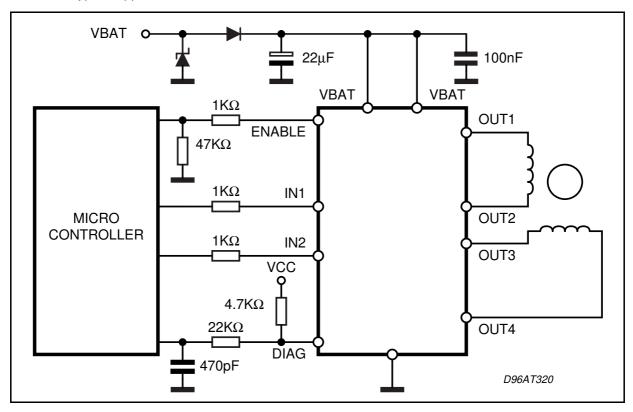


Figure 3: Typical Application with Shottky Diodes

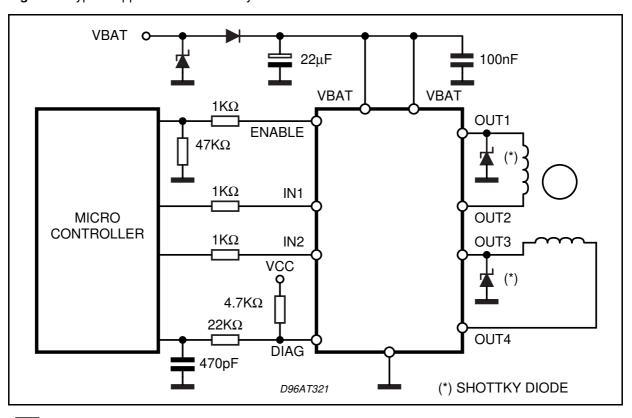


Figure 4: Initialization.

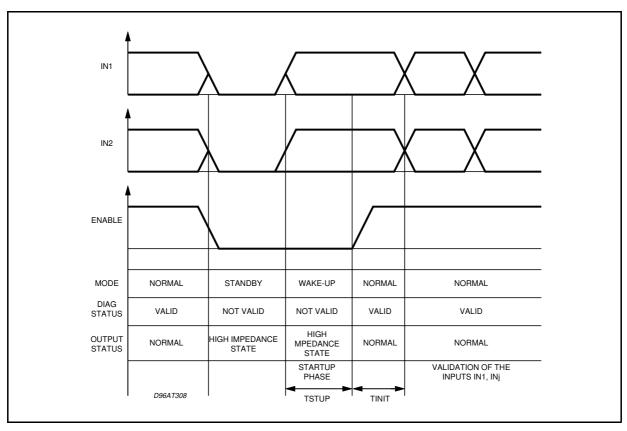


Figure 5: Normal Condition.

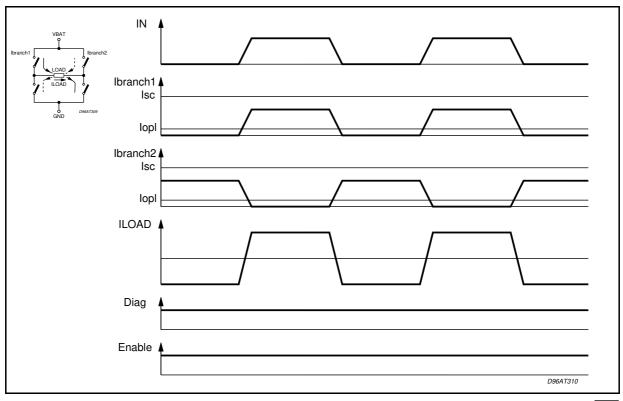


Figure 6: Short-circuit Condition.

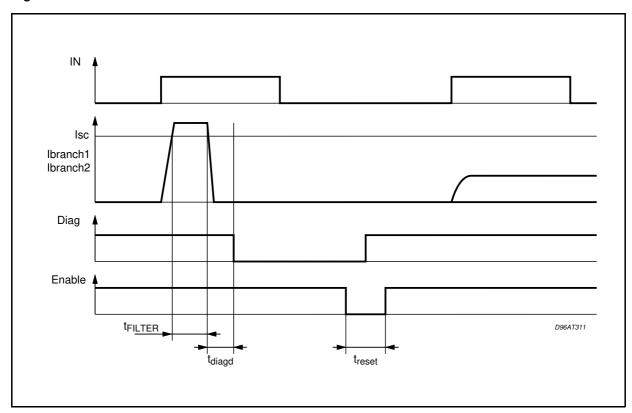


Figure 7: short circuit condition: no detection (NOT TESTED)

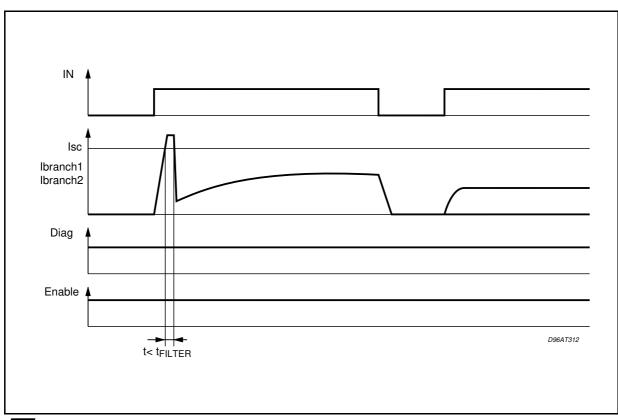


Figure 8: Open Load Condition 1: Detection

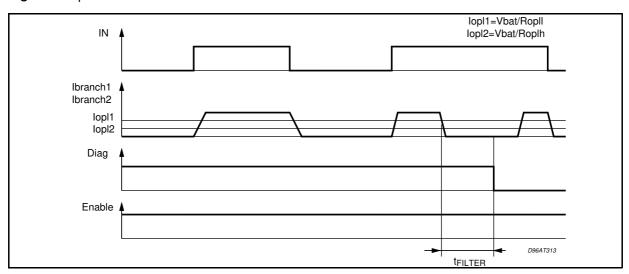


Figure 9: Open Load Condition 1: No Detection (NOT TESTED)

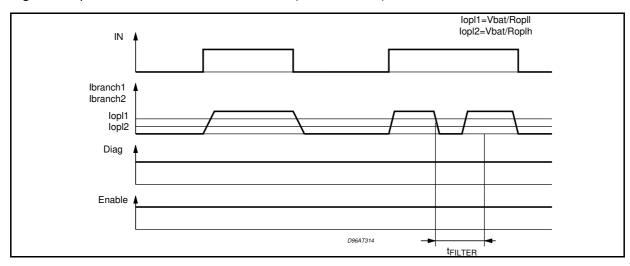


Figure 10: Open Load Condition 2: No Current after (ENABLE)

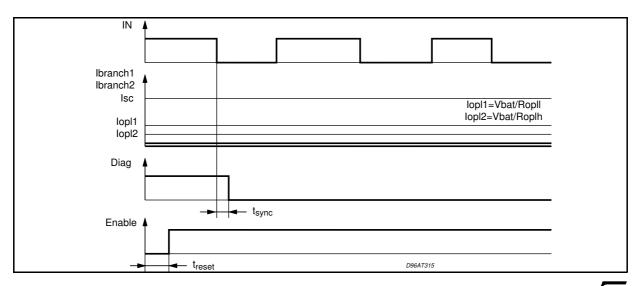


Figure 11: Open Load Condition 3

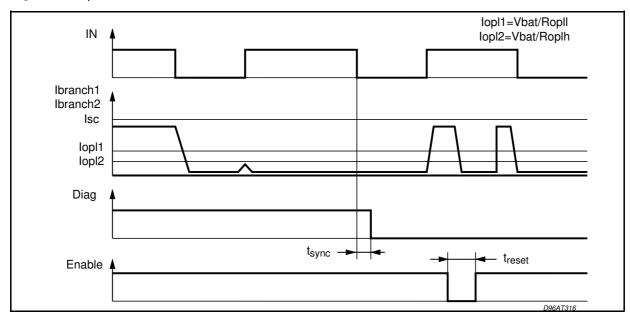


Figure 12: Open Load Condition 4: No Detection

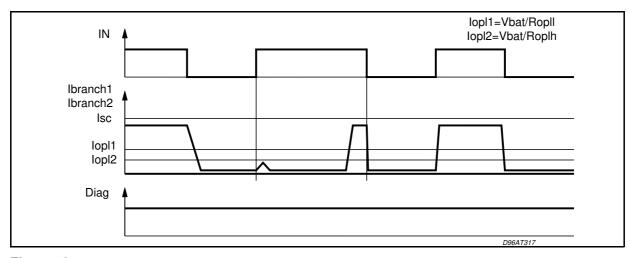
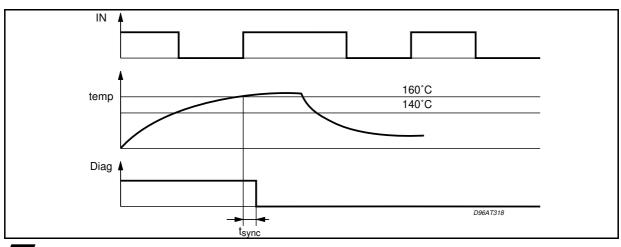
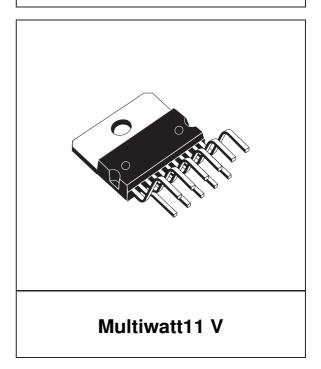


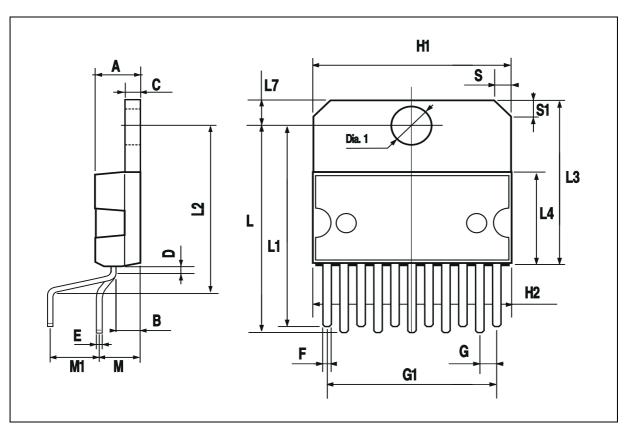
Figure 13: Overtemperature Detection



DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
Α			5			0.197
В			2.65			0.104
C			1.6			0.063
D		1			0.039	
Е	0.49		0.55	0.019		0.022
F	0.88		0.95	0.035		0.037
G	1.45	1.7	1.95	0.057	0.067	0.077
G1	16.75	17	17.25	0.659	0.669	0.679
H1	19.6			0.772		
H2			20.2			0.795
L	21.9	22.2	22.5	0.862	0.874	0.886
L1	21.7	22.1	22.5	0.854	0.87	0.886
L2	17.4		18.1	0.685		0.713
L3	17.25	17.5	17.75	0.679	0.689	0.699
L4	10.3	10.7	10.9	0.406	0.421	0.429
L7	2.65		2.9	0.104		0.114
М	4.25	4.55	4.85	0.167	0.179	0.191
M1	4.73	5.08	5.43	0.186	0.200	0.214
S	1.9		2.6	0.075		0.102
S1	1.9		2.6	0.075		0.102
Dia1	3.65		3.85	0.144		0.152

# OUTLINE AND MECHANICAL DATA



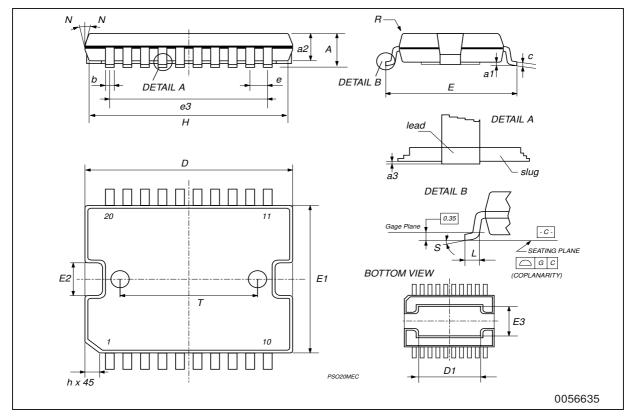


DIM.	mm			inch				
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
Α			3.6			0.142		
a1	0.1		0.3	0.004		0.012		
a2			3.3			0.130		
а3	0		0.1	0.000		0.004		
b	0.4		0.53	0.016		0.021		
С	0.23		0.32	0.009		0.013		
D (1)	15.8		16	0.622		0.630		
D1	9.4		9.8	0.370		0.386		
Е	13.9		14.5	0.547		0.570		
е		1.27			0.050			
e3		11.43			0.450			
E1 (1)	10.9		11.1	0.429		0.437		
E2			2.9			0.114		
E3	5.8		6.2	0.228		0.244		
G	0		0.1	0.000		0.004		
Н	15.5		15.9	0.610		0.626		
h			1.1			0.043		
L	0.8		1.1	0.031		0.043		
N	8° (typ.)							
S	8° (max.)							
Т		10			0.394			

- (1) "D and E1" do not include mold flash or protusions.
   Mold flash or protusions shall not exceed 0.15mm (0.006")
   Critical dimensions: "E", "G" and "a3".

# **OUTLINE AND MECHANICAL DATA**





#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS. WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID1418 Rev 4 12/12